ACDL1V Automotive class D audio inductor alloy powder



Product features

- AEC-Q200
- Shielded construction
- Dual inductors in a single package
- 12.2 mm x 9.8 mm footprint surface mount package in a 11.6 mm height
- Low loss, low DCR
- High I_{sat}
- · Alloy powder core material
- Moisture sensitivity level (MSL) 1

Applications

Automotive class D audio amplifiers

- Automotive 12 V/24 V/48 V bidirectional DC/DC converters
- EV battery chargers
- On-board-chargers
- xEV Electrical systems (multiple phases)

Environmental compliance and general specifications

- Storage temperature range (component): -55 °C to +155 °C
- Operating temperature range: -55 °C to +155 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant





Product specifications

Part number⁵	OCL ³ (μΗ) ± 20%	I _{rms} ³ (A)	I _{sat} ⁴ (A)	DCR (mΩ) typical @ +25 °C	DCR (mΩ) maximum @ +25 °C	SRF (MHz) reference
ACDL1V1004-5R6-R	5.6	6.0	9.0	20	24	15
ACDL1V1004-7R5-R	7.5	5.3	8.0	25	30	14
ACDL1V1004-100-R	10	4.4	6.4	30.5	36.6	12
ACDL1V1004-150-R	15	4.1	5.0	43.5	52.2	10
ACDL1V1004-220-R	22	3.5	4.5	62	74.4	8.0
ACDL1V1004-330-R	33	2.8	4.0	100	120	7.0

1. Open circuit inductance (OCL) test parameters: 100 kHz, 1.0 V $_{\rm ms'}$ 0.0 Adc, +25 °C

2. All test data referenced to +25°C ambient.

case operating conditions verified in the end application.

4. I_{sat} (per winding): Peak current for approximately 30% rolloff @ +25 °C.

5. Part number definition: ACDL1V1004-xxx-R

(ACDL1V1004)= Product code and size

3. I_ms (per winding): DC current for an approximate temperature rise of 40 $^\circ$ C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components xxx= inductance value in ,µH, R= decimal point, if no R is present then last character equals number of zeros will affect the temperature rise. It is recommended that the temperature of the part not exceed +155 °C under worst -R suffix = RoHS compliant

2.9

1.5

33

9.7

3.4

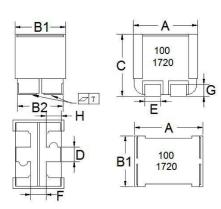
Note: Rated DC current: The lower value of ${\rm I}_{\rm ms}$ or ${\rm I}_{\rm sat}$

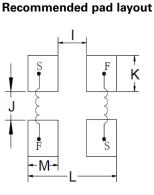
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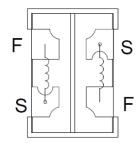
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Mechanical parameters, schematic, pad layout (mm)









Part number A		B1	B2	С	D	E	F	G	н	т
ACDL1V1004 12	2 ± 0.20	9.6 ± 0.20	8.7 ± 0.25	11.3 ± 0.30	1.95 ± 0.15	2.8 ± 0.10	3.4 minimum	2.3 ± 0.30	2.5 ± 0.30	≤ 0.1

Part marking: example 100

1720

100= inductance value in μ H, last digit indicates number of zeros (100=10 μ H)

1720= (randomly generated lot code)

PCB layout is for reference

Recommended solder paste thickness at 0.15 mm and above.

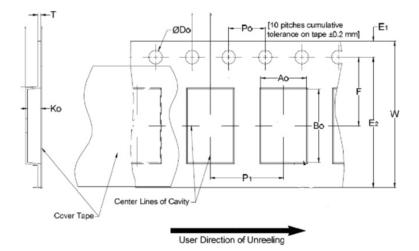
Traces or vias underneath the inductor is not recommended.

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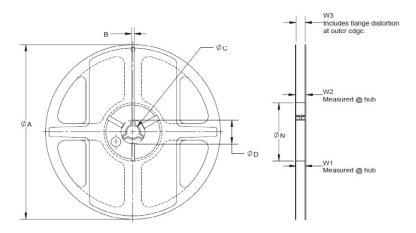
Packaging information (mm)

Drawing not to scale

Supplied in tape and reel packaging, 300 parts per 13" diameter reel (EIA-481 compliant)



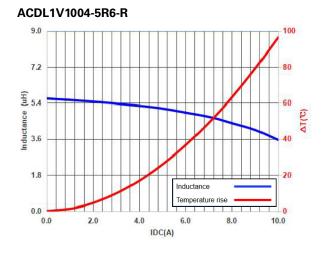
W	24.0 ± 0.3
F	11.5 ± 0.1
E1	1.75 ± 0.10
E2	NA
P0	4 ± 0.10
P1	16.0 ± 0.1
ØD0	1.5 ± 0.1
A0	10.0 ± 0.1
B0	12.5 ± 0.1
К0	11.55 ± 0.10
Т	0.50 ± 0.05



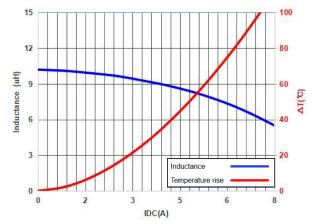
 330 ± 2 А В 2.3 ± 0.3 С 13 + 0.5/-0.2 D 20.2 minimum Ν 97 ± 0.5 W1 24.4 + 2.0/-0 W2 30.4 maximum W3 NA

Shape & Appearance For Reference Only

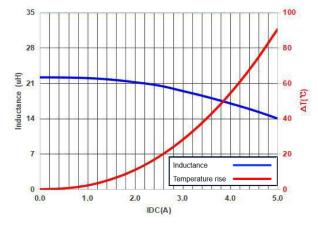
Inductance and temperature rise vs. Idc

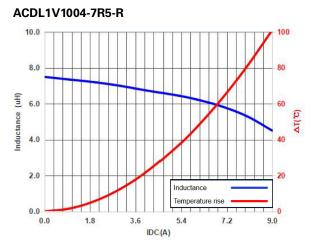


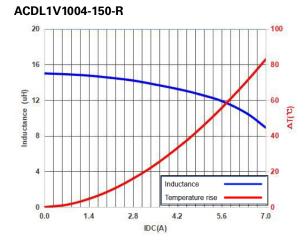
ACDL1V1004-100-R

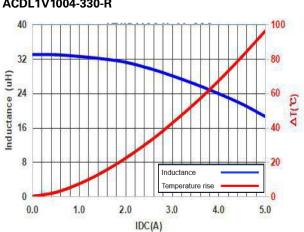












ACDL1V1004-330-R

Solder reflow profile

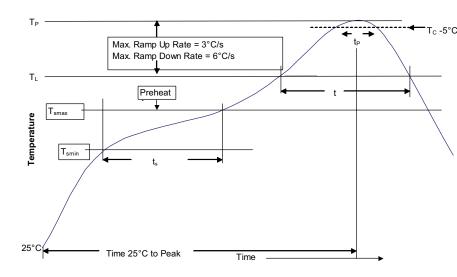


Table 1 - Standard SnPb solder (T_c)

C Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_c)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder	
Preheat and soak • Temperature min. (T _{smin})	100 °C	150 °C	
• Temperature max. (T _{smax})	150 °C	200 °C	
• Time (T _{smin} to T _{smax}) (t _s)	60-120 seconds	60-120 seconds	
Ramp up rate T _L to T _p	3 °C/ second max.	3 °C/ second max.	
Liquidous temperature (TL) Time (t_) maintained above ${\rm T_L}$	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time $(t_p)^*$ within 5 °C of the specified classification temperature (T_c)	20 seconds*	30 seconds*	
Ramp-down rate (T _p to T _L)	6 °C/ second max.	6 °C/ second max.	
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.	

 * Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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